

CUSTOMER: _____

DATE: _____

APPROVAL SPECIFICATION

PRODUCT NAME: SMD power inductor

YOUR PART NO. :

OUR PART NO. : MPIT6028-series

RECEPTION THE SPECIFICATION HAS BEEN ACCEPTED.		
COMPANY:		DATE:
CFMD	CHKD	RCVD

MANUFACTURING NAME

深圳市麦捷微电子科技股份有限公司

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1. Scope

This specification applies to the MPIT series of SMD power inductors.

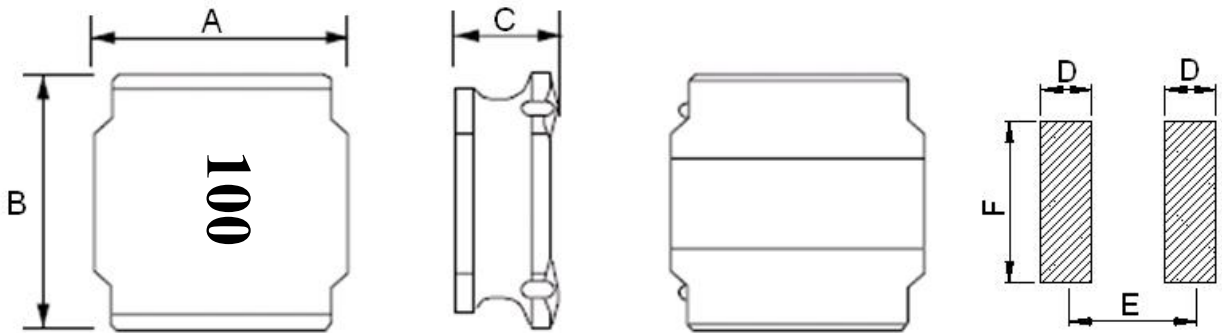
2. Product Identification

MPIT 6028 – 100 M - LF
 ① ② ③ ④ ⑤

- ① Series name
- ② Product dimensions
- ③ Inductance Value: (6R3:6.3uH 100: 10uH; 101:100uH)
- ④ Inductance Tolerance: (K:10% ; M:20% ; N:30%)
- ⑤ Lead free products

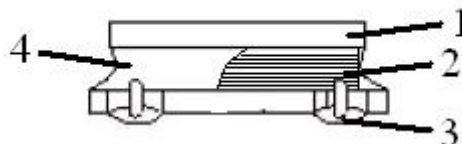
3. Construction

3.1 Shape and dimensions



Dimensions in mm						
Model	A	B	C	D	E	F
MPIT6028	6.0±0.3	6.0±0.3	3.0 Max.	1.6 ref.	4.7 ref.	5.7 ref.

3.2 Material List



No.	Item	Material
1	DR Core	Ferrite
2	Wire	Enameled Copper Wire
3	Solder	Sn99.7-Cu0.3
4	Epoxy	Epoxy Adhesive

4. Testing Conditions

Unless otherwise specified

Temperature : Ordinary Temperature (5 to 35°C)

Humidity : Ordinary Humidity (25 to 85% RH)

Atmospheric Pressure : 86 to 106 kPa

In case of doubt

Temperature : 20±2°C

Humidity : 60 to 75% RH

Atmospheric Pressure : 86 to 106 kPa

5. Electrical Characteristics And Test Instruments

Operating temperature:-40~85°C

Storage temperature and Humidity Range: -40~125°C & 30% to 70%

Microgate Part No.	Customer Part No.	Inductance (uH)	DCR (mΩ)max	Isat (A) max	Irms (A) max
MPIT6028-0R9N-LF		0.9±30%	16.9	6.6	4.6
MPIT6028-1R5N-LF		1.5±30%	20.8	5.0	4.2
MPIT6028-2R2N-LF		2.2±30%	26	4.2	3.7
MPIT6028-3R0N-LF		3.0±30%	29.9	3.6	3.4
MPIT6028-4R7M-LF		4.7±20%	40.3	2.7	3.0
MPIT6028-6R8M-LF		6.8±20%	54.7	2.2	2.5
MPIT6028-100M-LF		10±20%	84.5	1.9	1.9
MPIT6028-150M-LF		15±20%	123.5	1.6	1.8
MPIT6028-220M-LF		22±20%	175.5	1.3	1.4
MPIT6028-330M-LF		33±20%	286	1.1	1.1
MPIT6028-470M-LF		47±20%	390	0.95	0.92
MPIT6028-680M-LF		68±20%	546	0.76	0.77
MPIT6028-101M-LF		100±20%	780	0.62	0.66

* CHROMA 3302 meter for L and DCR.

* CHROMA 3302 and 1320 meter for IDC.

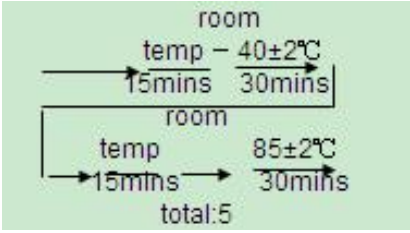
* L test condition: 100KHz/1V.

* IDC: $|L0A-L3.0A|/L0A \leq 30\%$ and temperature rise: $I_{rms} = 2.5A$ $\Delta T \leq 40^\circ C$

The part must be allowed high temperature : 125°C

6. Reliability and Test Condition

Item	Specifications	Test Method/Condition
Operating temperature range	-25°C ~ +85°C	Including temperature rise due to self-generated heat
Terminal strength-pull test	Terminal shall not be loosened or ruptured	A 5N. load shall be applied to both terminals in the axis direction for 60 sec.
Solderability test	The terminal shall be at least 90% covered with solder.	After fluxing, Inductor shall be dipped in a melted solder bath at 230±5 °C for 5 seconds.
Resistance to solvent test	There shall be no case deformation change in appearance obliteration of marking.	MIL-STD-105E II
Vibration test (low frequency)	1. Inductors shall be no evidence of electrical and mechanical damage. 2. Inductance shall not change more than=5%. 3. Q shall not change more than=20%	1. Amplitude: 1.5mm. 2. Frequency: 10~55~10Hz/min. 3. Direction: X.Y.Z. 4. Duration: 2 hrs/X.Y.Z.
Shock test		Inductors shall be dropped 10 from a height of 1m onto 3cm wooden board.
Resistance to soldering heat		Temp: 260±5°C, Time: 10±1sec
High temperature load life test	There shall be no evidence of Short or open circuiting.	1. temp: 85±2°C. 2. time: 1000±12 hours. 3. load: allowed DC current.
Humidity load life		1. temp: 40±2°C. 2. R.H: 90-95%. 3. time: 1000±12 hours. 4. load: allowed DC current.

Item	Required Characteristics	Test Method/Condition
Temperature characteristic		-25°C ~ +85°C
Humidity test		1. Temp:40±2°C. 2. R.H:90-95%. 3. Time:96±2 hours.
Cold test	1. Inductors shall be no evidence of electrical and mechanical damage 2. Inductance shall not change more than±5%.	1. Temp:-40±2°C. 2. Time:96±2 hours.
Thermal shock test	3. Q shall not change more than ±30%.	 <p>The diagram illustrates a thermal shock test cycle. It starts with a 'room temp' phase for 15 minutes. This is followed by a transition to a temperature of -40±2°C for 30 minutes. After this, there is another 15-minute 'room temp' phase. The cycle then transitions to a temperature of 85±2°C for 30 minutes. The total duration of the test is 5 hours.</p>
Dry heat test		1. temp:85±2°C 2. time: 96±2 hours

7. Recommended Soldering Conditions

Product can be applied to flow and reflow soldering.

(1) Flux, Solder

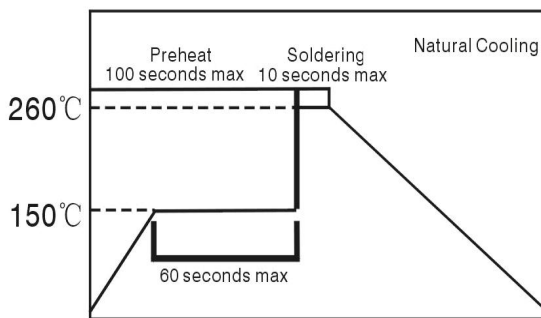
① Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).

② Use Sn solder.

(2) Flow soldering conditions

① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

② Standard soldering profile.



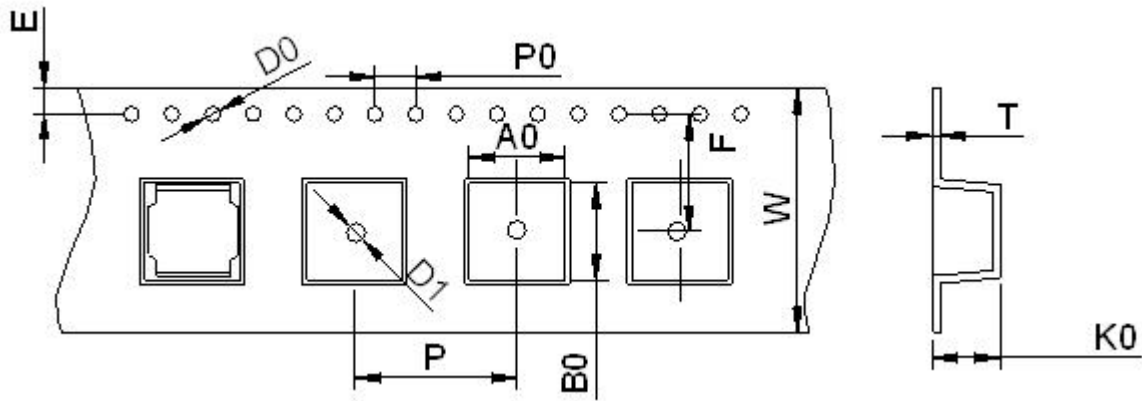
Pre-heating	150°C, 1 minute min
Peak	260°C, 10 seconds max

(3) Reflow soldering conditions

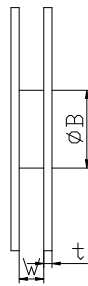
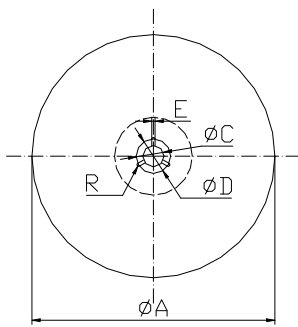
Profile Feature		Lead-Free Assembly
Average Ramp-Up Rate (Ts max. to Tp)		3°C /second max.
Preheat	- Temperature Min (Ts min.)	150 °C
	- Temperature Max (Ts max.)	200 °C
	- Time (ts min to ts max.)	60-180 seconds
Time maintained above	- Temperature (TL)	217 °C
	- Time (tL)	60-150 seconds
Peak/Classification Temperature (Tp)		260 °C
Peak/Classification Time (Tp)		3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)		20-40 seconds
Ramp-Down Rate		6°C/second max.
Time 25 °C to Peak Temperature		8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

9. Package Information (Unit: mm)



16.0±0.3	6.4±0.10	6.4±0.10	4.80±0.10	/	1.75±0.10	7.5±0.10	12.0±0.10	4.00±0.10	1.50±0.10	1.50±0.30	0.35±0.05
W	A0	B0	K0	K1	E	F	P	P0	D0	D1	T



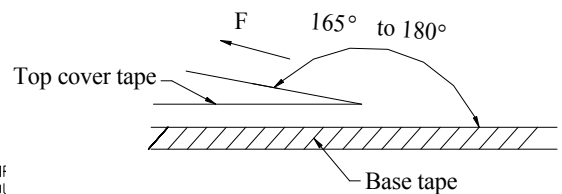
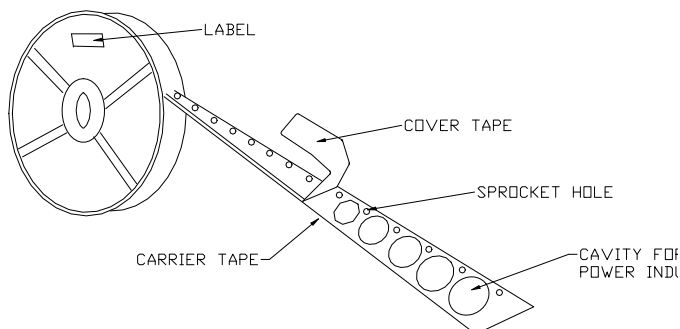
A	330±2.0
B	100±2.0
C	13.5±0.5
D	21±0.5
E	2.2
R	R1.0
W	16.5
t	2.5

Packing quantity: 2000pcs/reel

9.1 Peeling strength of cover tape:

The force tearing off cover tape is 30 to60 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room aim (hpa)	Peel Speed Mm/min
5-35	45-85	860-1060	300



10. Products Storage

(1) Storage period

Products which inspected in MICROGATE over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solderability should be checked if this period is exceeded.

(2) Storage conditions

Products should be storage in the warehouse on the following conditions:

Temperature: -10 ~+ 40°C

Humidity : Less than 80% relative and humidity

No rapid change on temperature and humidity

- (3) Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- (4) Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- (5) Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- (6) Products should be storage under the airtight packaged condition.

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